



NOTICES

DISCLAIMER

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BILL OF MATERIALS

Due to global supply shortages, component availability may be limited. We offer suggestions for alternative parts (and in some cases, general requirements for alternative parts). Alternative parts may require the circuit design to be modified (i.e. they may not be drop-in replacements). The customer should test any design prior to placing a larger order. The customer is welcome to contact LEE Ventus to discuss changes from the LEE Ventus standard design (including the use of alternative parts).

IMPORTANT NOTE

The Reference Package circuit design uses a microprocessor to control a DC-DC boost circuit. This function places a significant demand on the microprocessor's resources. Therefore LEE Ventus strongly recommends that this microprocessor is not used for any additional functionality beyond that implemented in the reference firmware, as to do so may cause malfunction of the circuit board.